

USUKI LAB.

[Development of High Thermal Conductivity Tool with Graphene]

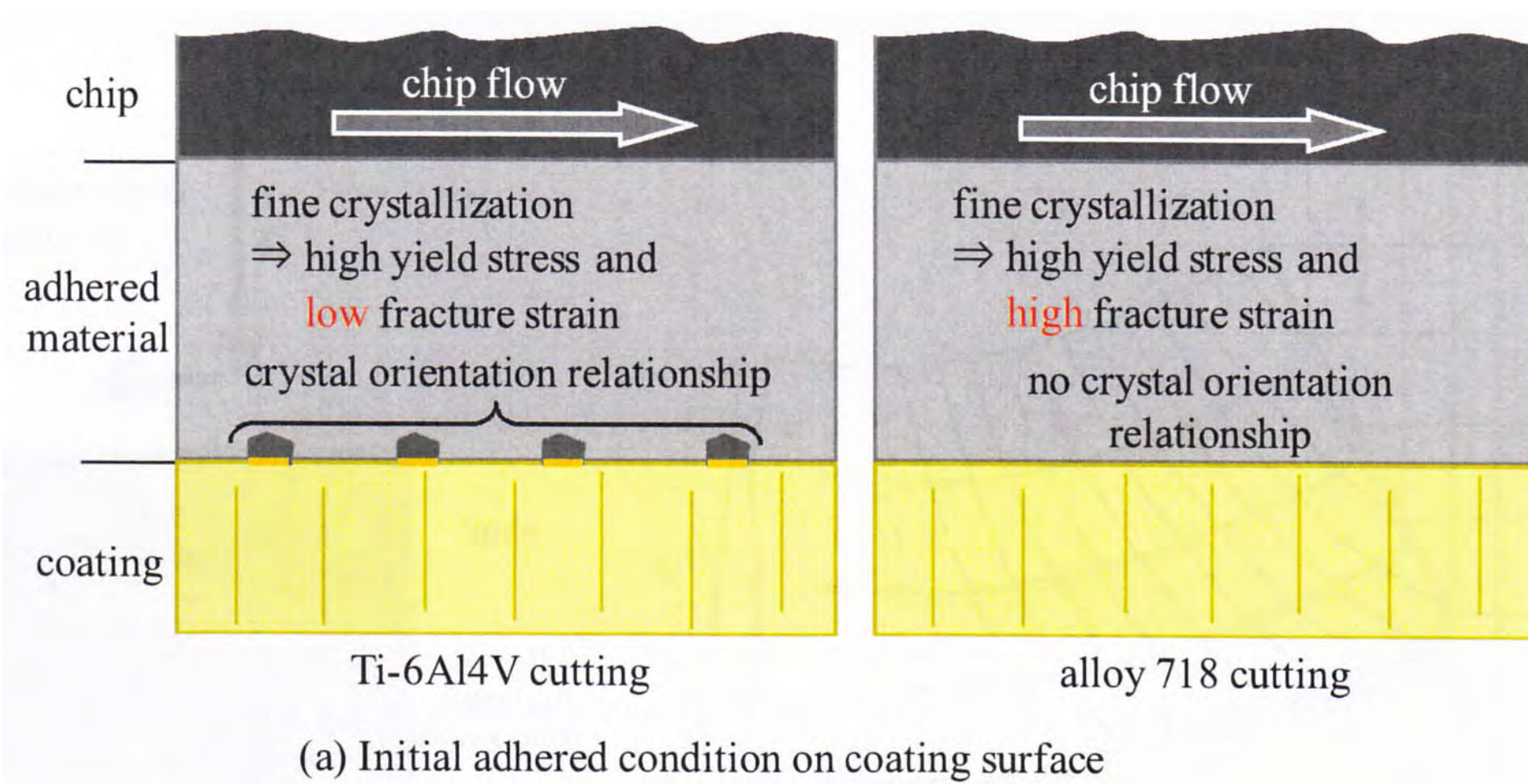
Department of Mechanical and Biofunctional Systems

Advanced Machining

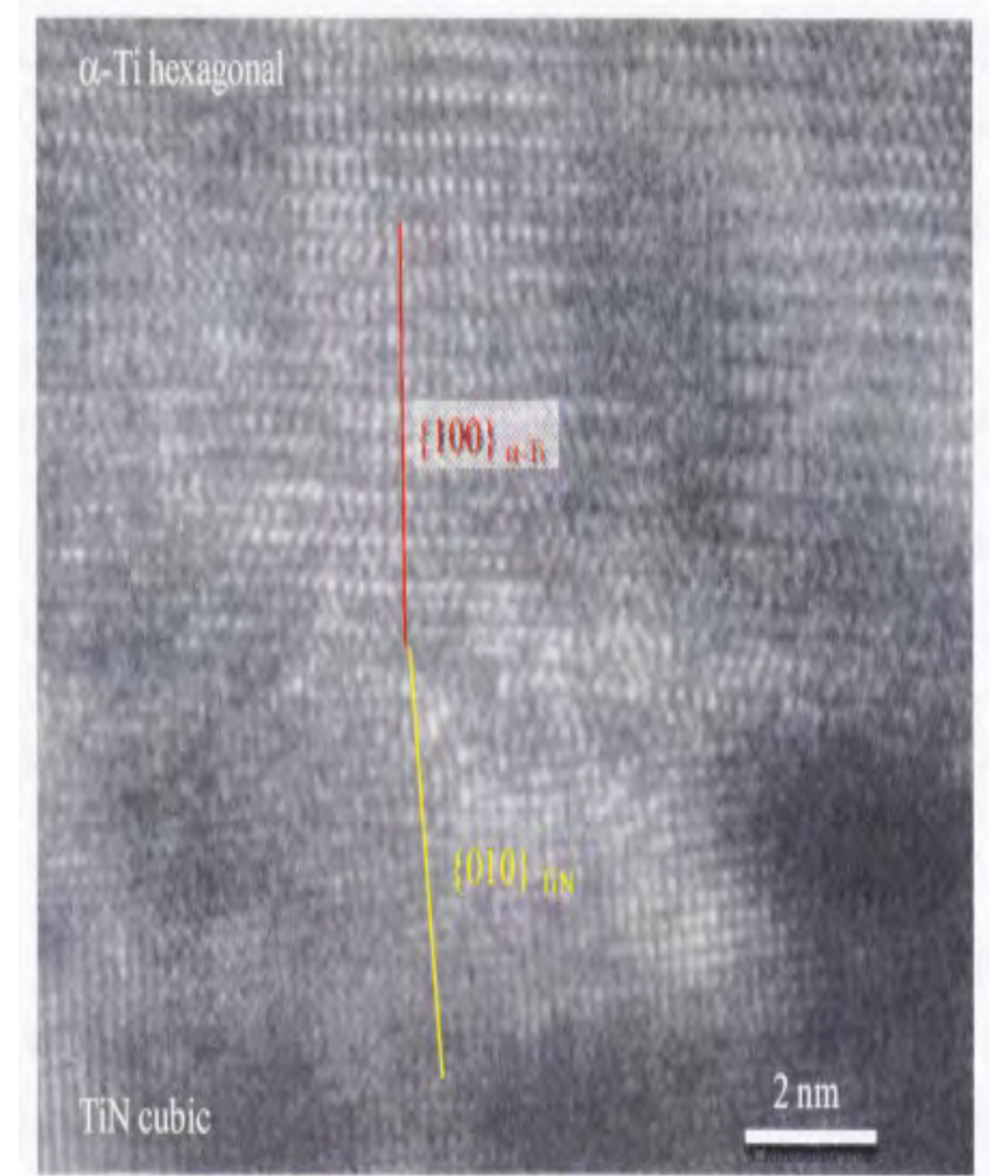
Department of Mechanical Engineering

Research assignment of cutting titanium alloy and superalloy

Surface of chip changes fine crystallization at interface between chip and coating
 ⇒ ~10 nm
 • Crystal orientation relationship
 • High Adhesive strength

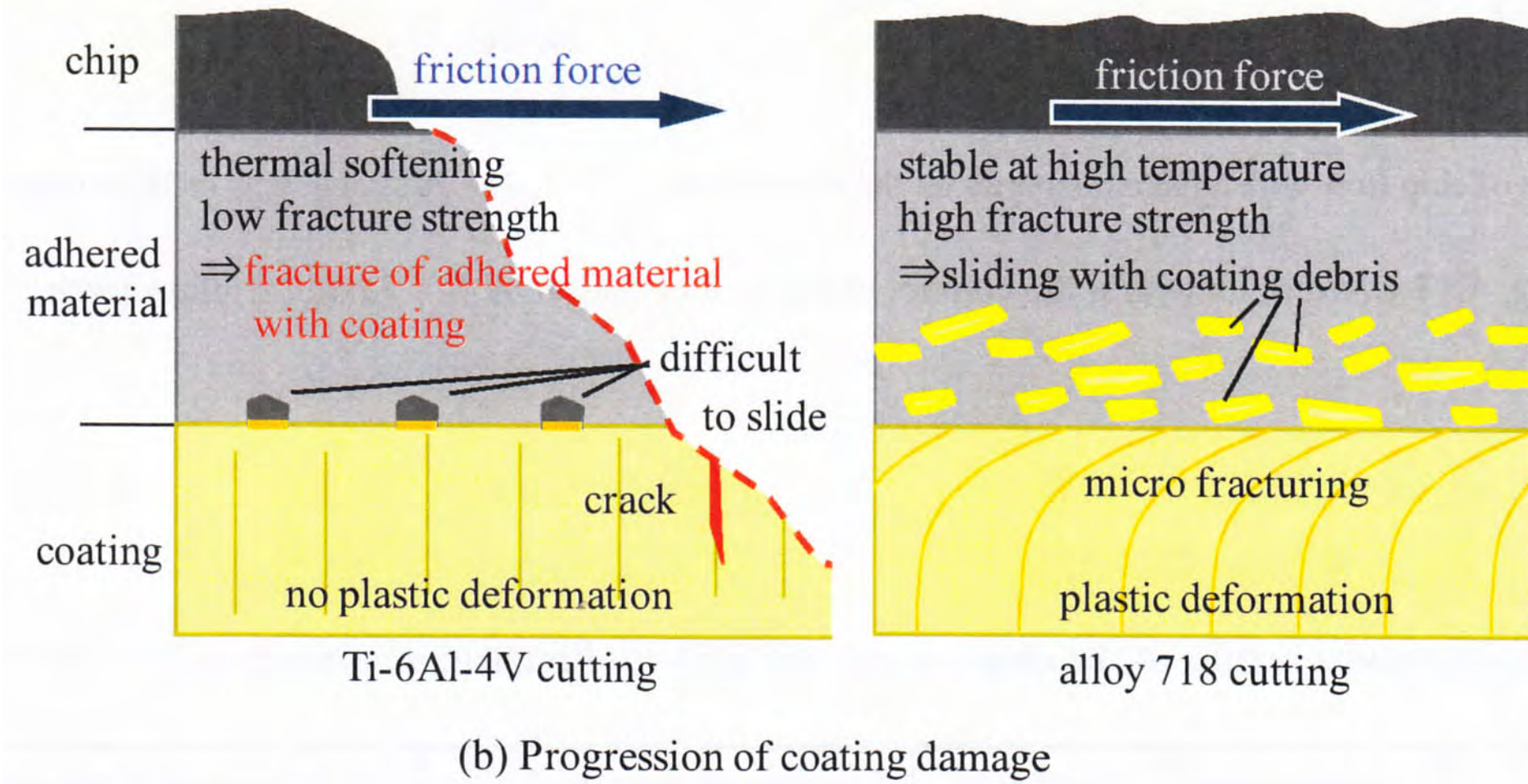


Surface of chip changes fine crystallization at interface between chip and coating
 ⇒ ~100 nm
 • No crystal orientation relationship
 • Low Adhesive strength



TEM image of interface between adhered material and TiN coating

High temperature Low stress
 plastic deformation of coating doesn't occur
 ① Crack occurs on adhered material by shear stress
 ② Crack spreads to coating layer
 ③ Fracture of coating layer



High temperature High stress
 Surface of coating deforms and fractures

First step of adhesion between work material and tool is **fine crystallization of adhered material**
 ⇒ Adhesion by interatomic force progresses tool wear

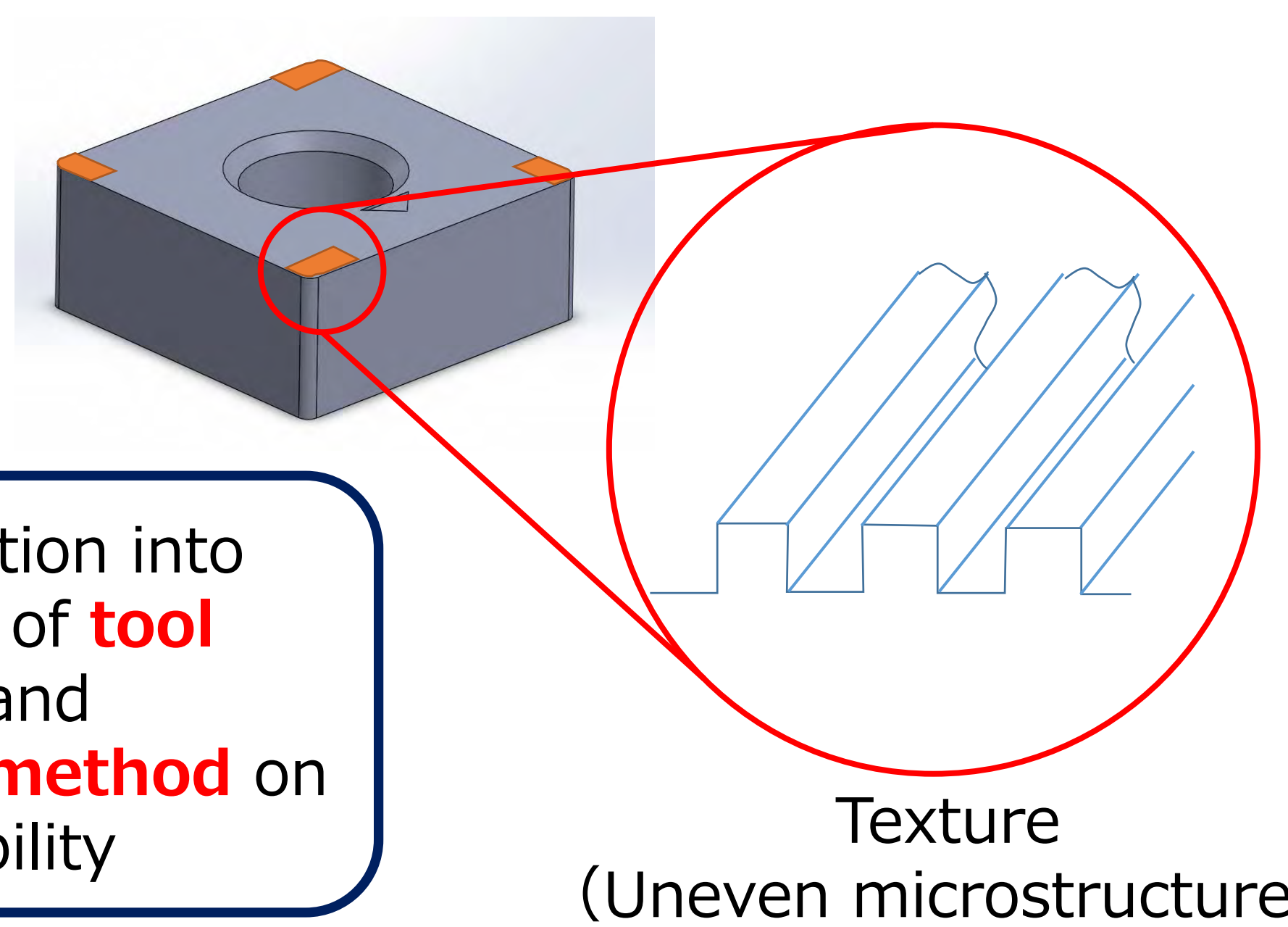
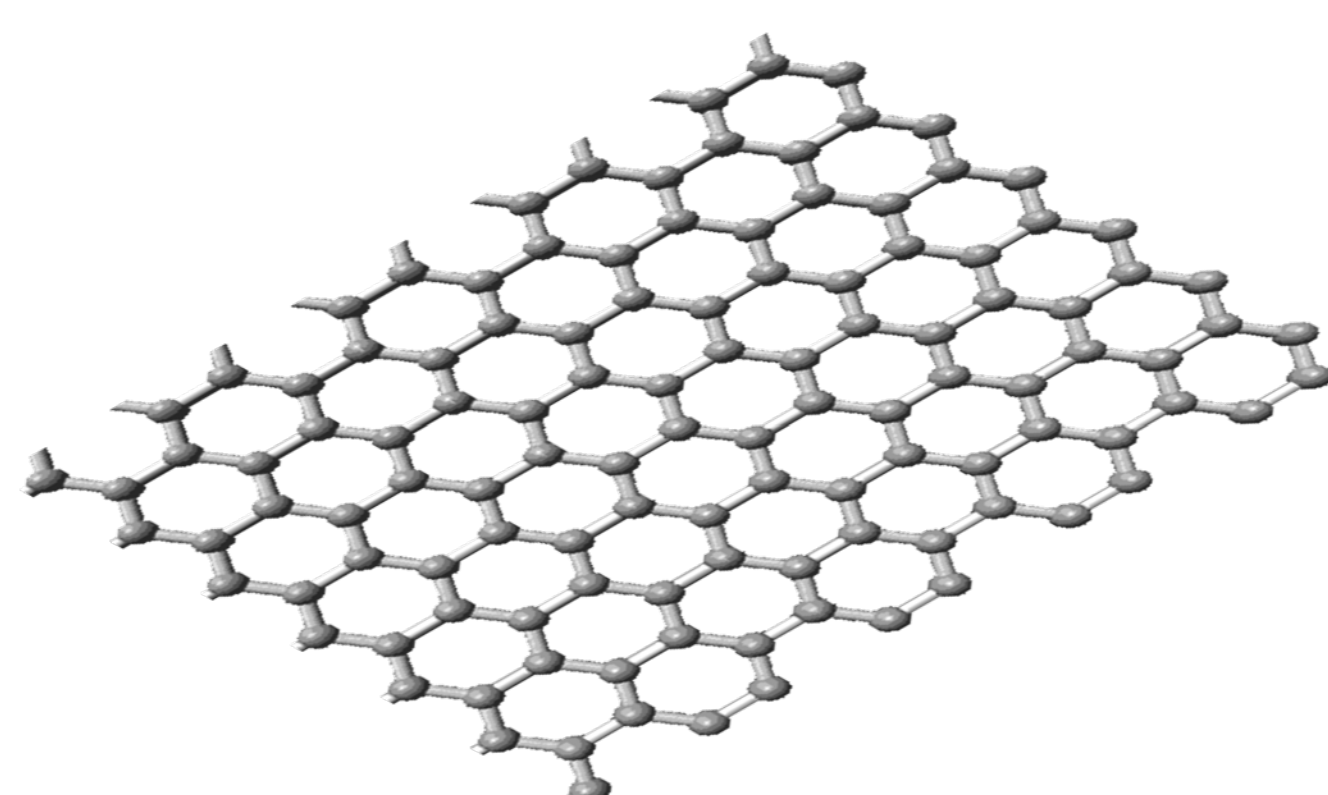
Wear processes of TiN coated tool when cutting Ti-6Al-4V and Inconel 718

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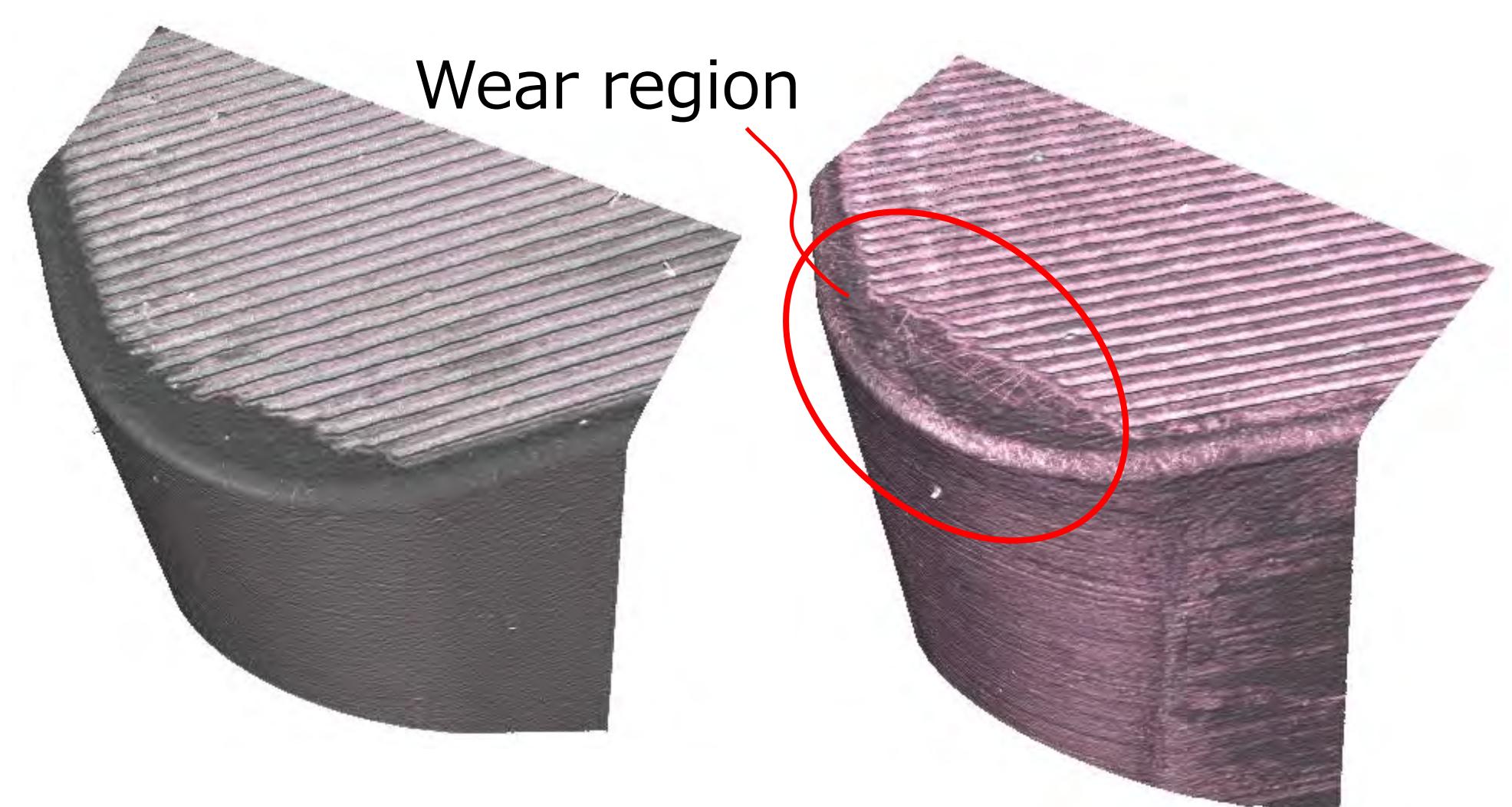
Key point are decrease cooling velocity of work material and cutting heat at edge of tool, to prevent fine crystallization
 ⇒ One of the solutions, we try to **development of high thermal conductivity tool with graphene.**

SP2 structure
 (Carbon nanotube and graphite have same structure)
 ⇒ High thermal conductivity

Ideal thermal conductivity 5800 W/m · K



Investigation into influence of **tool texture** and **coating method** on machinability



Comparison between edge of tool before/after cutting